

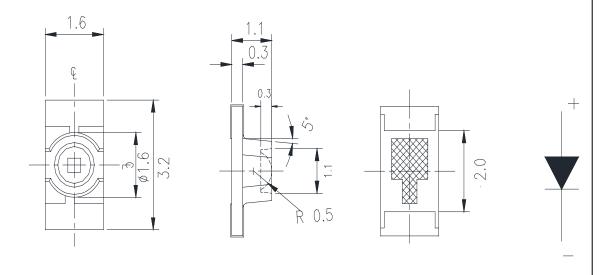
### **Features**

- 3.2mm\*1.6mm SMT LED, Super thin (1.1H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Products

# **Applications**

• Backlight and Indicator

## **Package Dimensions**



#### **Notes:**

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2$ mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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### FSL-R3216110G-FATNPRA60

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Sel	lection	Guide

Part No	Lens Type	Dice	Emitted Color
FSL-R3216110G-FATNPRA60	Water Clear	AlInGaP	Green

# Electrical / Optical Characteristics At Ta=25 °C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity	18	90		mcd	IF=20mA
201/2	Viewing Angle		60		deg	IF=20mA
入 Peak	Peak Emission Wavelength		570		nm	IF=20mA
λd	Dominant Wavelength	564.5	571.0	577.5	nm	IF=20mA
Δλ	Spectral Line Half-Width		15		nm	IF=20mA
VF	Forward Voltage	1.75	2.0		V	IF=20mA
IR	Reverse Current			10	μА	VR 5V

Note:

# **Absolute Maximum Ratings At Ta=25℃**

Parameter	Green		
Power Dissipation	75	mW	
Peak Forward Current[1]	80	mA	
Continuous Forward Current	30	mA	
Dreading Linear From50°C	0.4	mA/℃	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM)	2000	V	
Operating Temperature Range	-55°C to + 85°C		
Storage Temperature Range	-55°C to + 85°C		
Soldering Condition	260°C For5 Seconds		

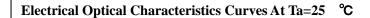
Note:

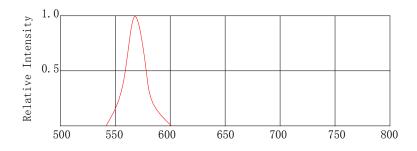
 $1.\ 1/10 Duty Cycle, 0.1 ms Pulse Width$ 

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 $<sup>1.\,\</sup>theta1/2$  is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value







Wavelength  $\lambda$  (nm)

Fig. 1 Relative Intensity vs. Wavelength

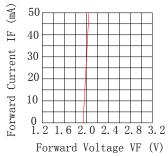


Fig. 2 Forward Current VS. Forward Voltage

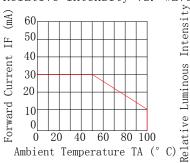


Fig. 3 Forward Current Derating Curve

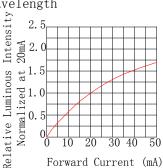
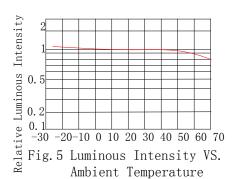
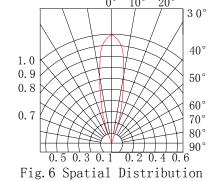


Fig. 4 Relative Luminous Intensity VS. Forward Current





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# **Bin Range Of Luminous Intensity**

Symbol	Bin Code	Min.	Max.	Unit	Condition
Iv	M	18	28	mcd	IF=20mA
	N	28	45		
	P	45	72		
	Q	72	112		
	R	112	180		
	S	180	280		

## **Bin Range Of Forward Voltage**

Symbol	Bin Code	Min.	Max.	Unit	Condition
VF	V2	1.75	1.95	V	IF=20mA
	V3	1.95	2.15		
	V4	2.15	2.35		
	V5	2.35	2.55		

# **Bin Range Of Dominate Wavelength**

Symbol	Bin Code	Min.	Max.	Unit	Condition
入 d	В	564.5	567.5	nm	IF=20mA
	С	567.5	570.5		
	D	570.5	573.5		
	Е	573.5	577.5		

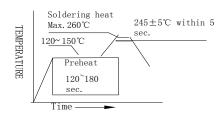
#### Notes:

- 1. Tolerance of Luminous Intensity +/-20  $\!\%$
- 2. Tolerance of Forward Voltage  $\pm -0.15V$
- 3. Tolerance of the Dominate Wavelength +/- 2nm

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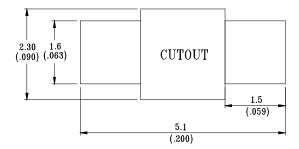
#### **SMT Reflow Soldering Instructions**



#### Notes:

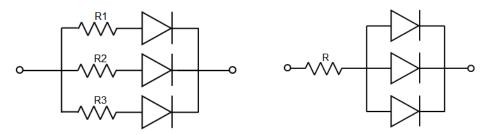
- Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a
  wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must
  be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

### **Recommended Soldering Pad Dimensions**



### **Application**

In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.



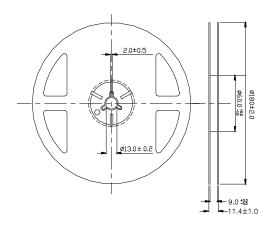
Circuit model A

Circuit model B

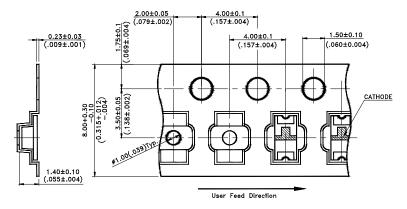
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## **Reel Dimensions**



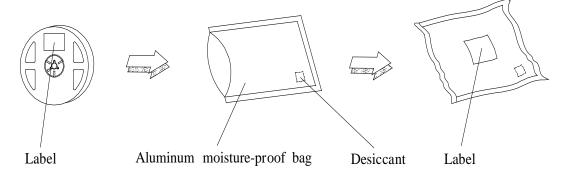
## Package Specifications (Units: mm (inches))



#### Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in  $5\sim30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept in 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

## **Moisture Resistant Packaging**



Remark: Add Desiccant into Aluminum moisture-proof bag

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# **Reliability Test Items Conditions**

Classification	Test Item	Test Conditions	Test hours	Result
	Operation Life	Connect with a power IF=20mA Ta=Under room temperature	1000Hrs	0/20
F 1	High Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	High Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
Temperature Cycling		-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C ~±5°C ~+85°C ~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

# Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	IF=20mA	Over U×1.2
Reverse current	Ir(µA)	V <sub>R</sub> =5V	Over U×2
Luminous intensity	Iv(mcd)	Ir=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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